

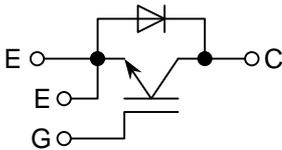
MBN600GR12A

[Rated 600A/1200V, Single-pack type]

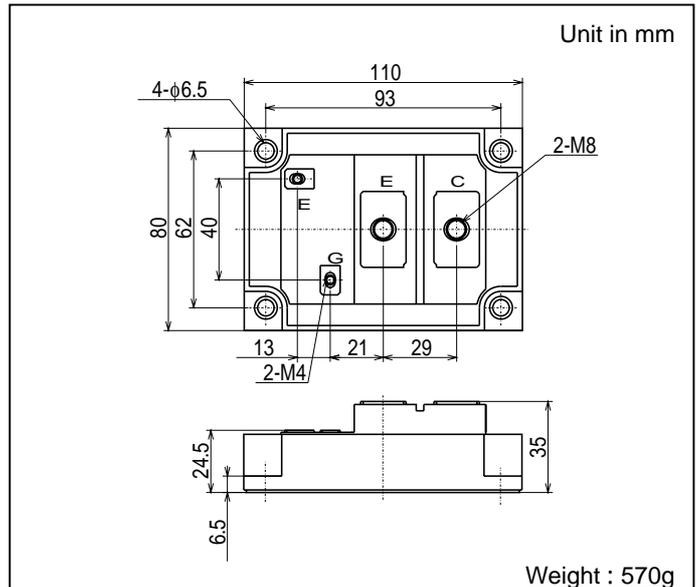
FEATURES

- Low saturation voltage and high speed.
- Low turn-OFF switching loss.
- Low noise due to built-in free-wheeling diode.
(Ultra Soft and Fast recovery Diode (USFD))
- High reliability structure.
- Isolated heat sink (terminals to base).

CIRCUIT DIAGRAM



OUTLINE DRAWING



ABSOLUTE MAXIMUM RATINGS (T_c=25°C)

| Item | Symbol | Unit | Value | |
|-----------------------------|------------------|------------------|-------------------|---------------------------|
| Collector-Emitter Voltage | V _{CEs} | V | 1200 | |
| Gate-Emitter Voltage | V _{GES} | V | ±20 | |
| Collector Current | DC | I _C | 600 | |
| | 1ms | I _{CP} | 1200 | |
| Forward Current | DC | I _F | 600 ^{*1} | |
| | 1ms | I _{FM} | 1200 | |
| Collector Power Dissipation | P _C | W | 3790 | |
| Junction Temperature | T _j | °C | -40 ~ +150 | |
| Storage Temperature | T _{stg} | °C | -40 ~ +125 | |
| Isolation Voltage | V _{iso} | V _{RMS} | 2500(AC 1 minute) | |
| Screw Torque | Terminals(M4/M8) | — | N·m | 1.37 / 7.84 ^{*2} |
| | Mounting | | | 2.94 ^{*3} |

Notes; *1 : RMS current of diode ≤ 180 Arms

*2 : Recommended value 1.18 / 7.35 N·m

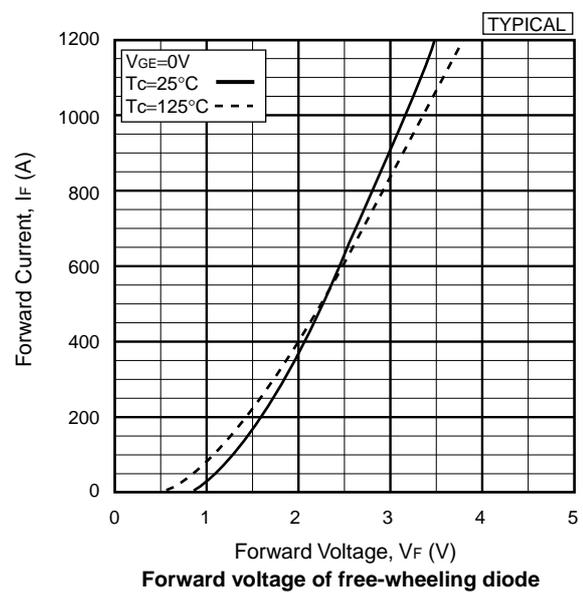
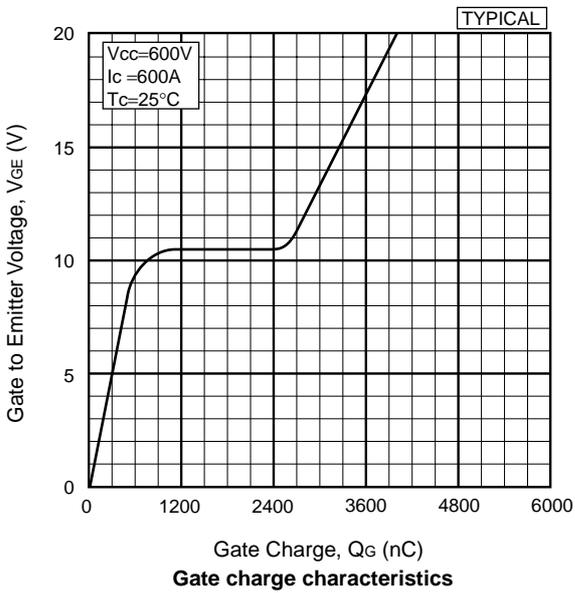
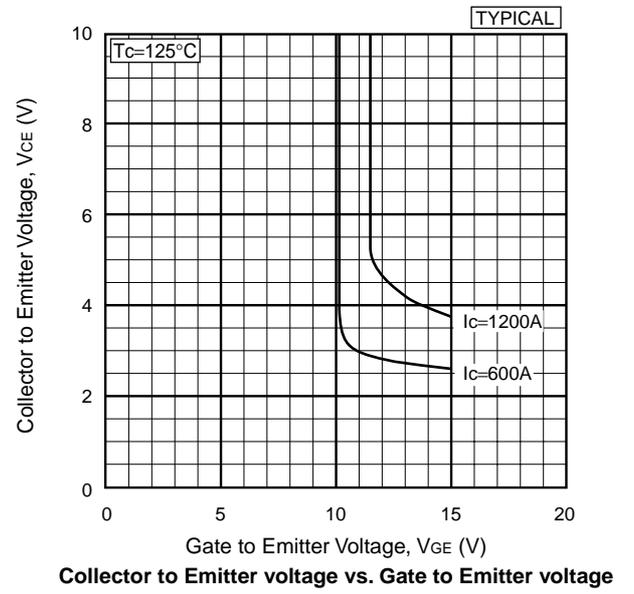
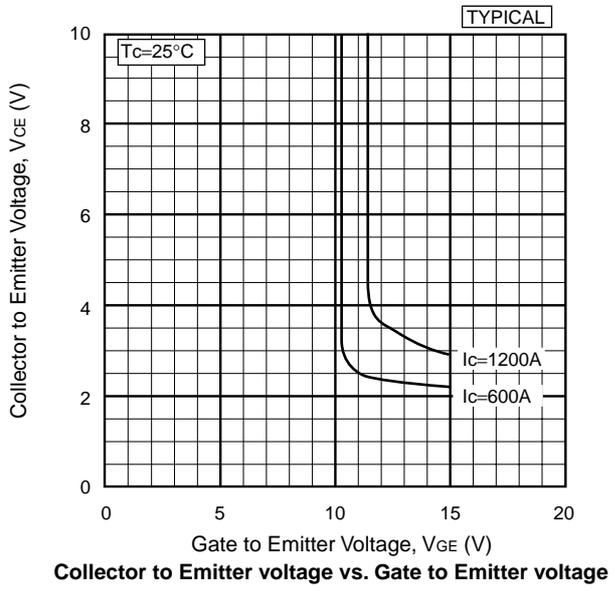
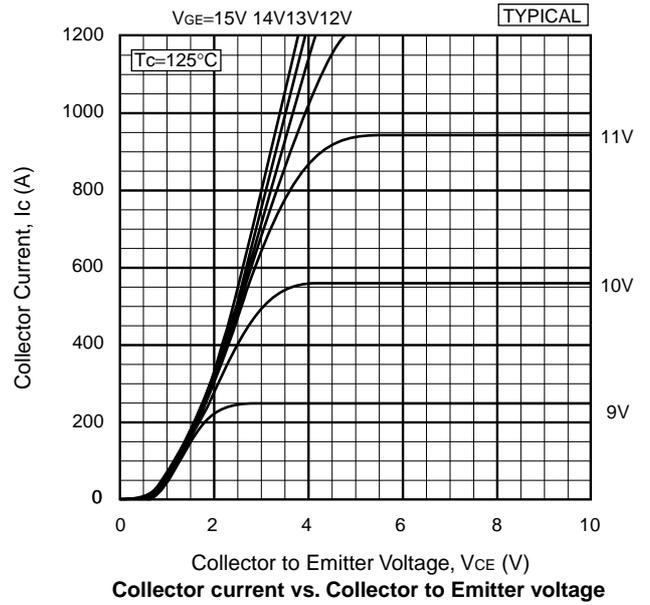
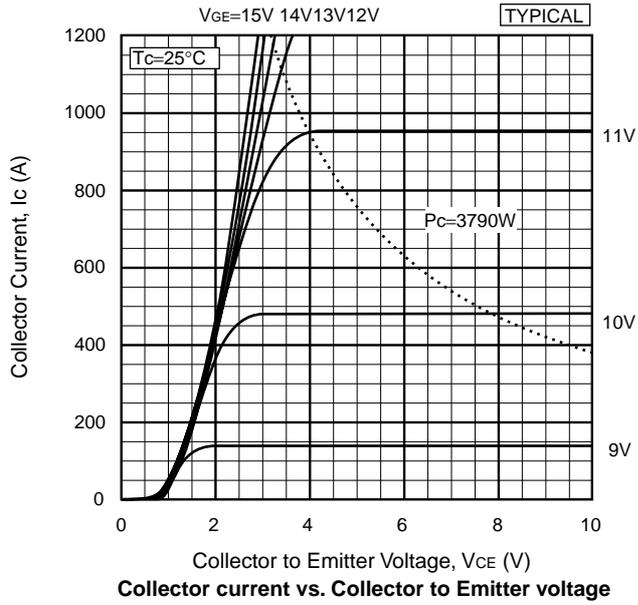
*3 : Recommended value 2.45 N·m

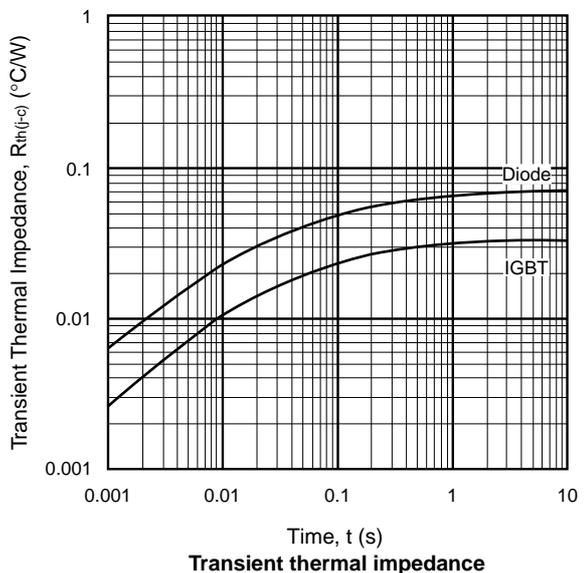
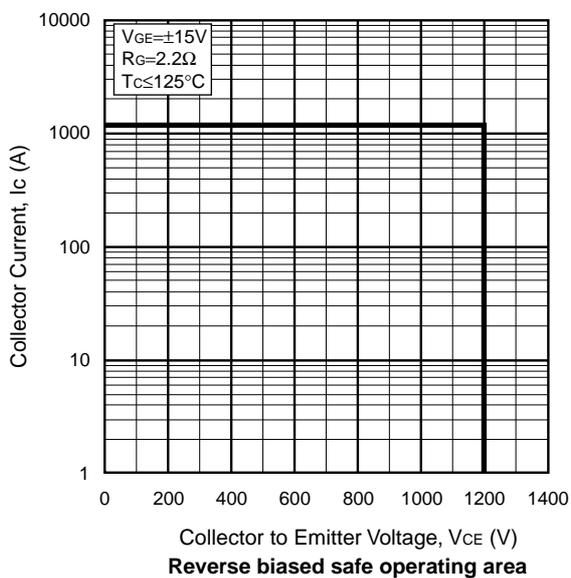
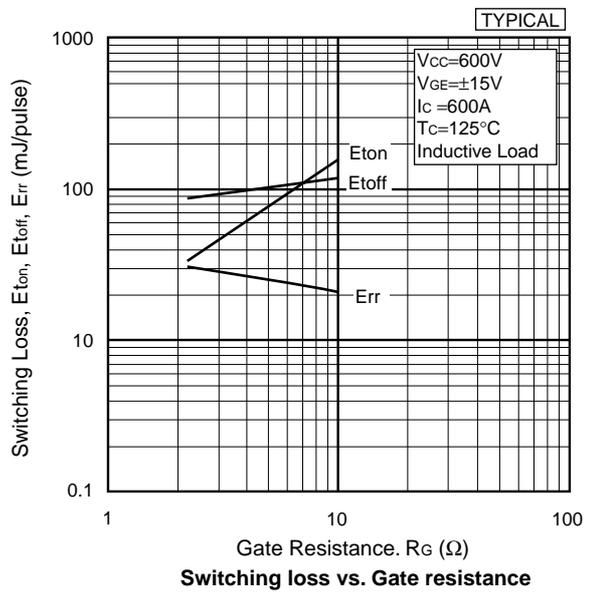
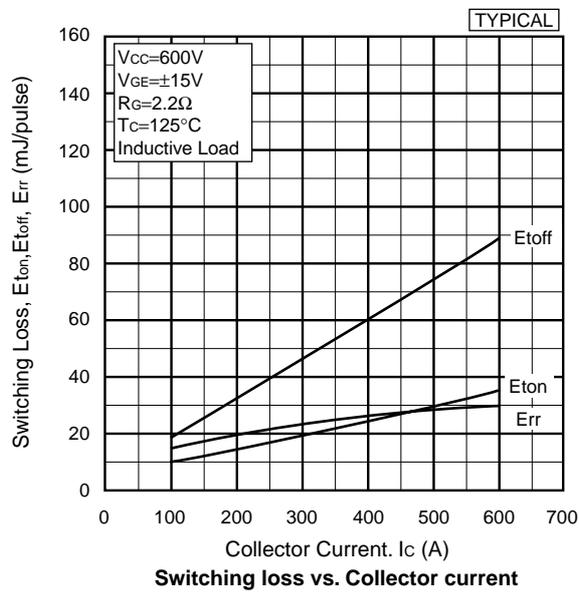
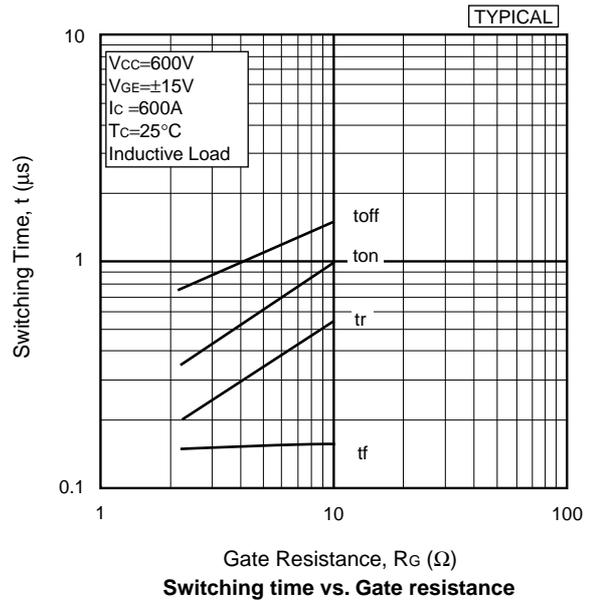
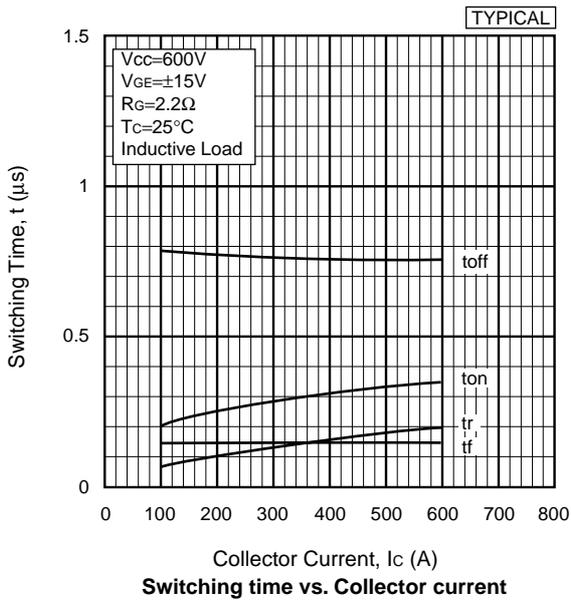
CHARACTERISTICS (T_c=25°C)

| Item | Symbol | Unit | Min. | Typ. | Max. | Test Conditions | |
|--------------------------------------|----------------------|----------------------|------|-------|------|--|------------------|
| Collector-Emitter Cut-Off Current | I _{CEs} | mA | — | — | 1.0 | V _{CE} =1200V, V _{GE} =0V | |
| Gate-Emitter Leakage Current | I _{GES} | nA | — | — | ±500 | V _{GE} =±20V, V _{CE} =0V | |
| Collector-Emitter Saturation Voltage | V _{CE(sat)} | V | — | 2.2 | 2.8 | I _C =600A, V _{GE} =15V | |
| Gate-Emitter Threshold Voltage | V _{GE(To)} | V | — | — | 10 | V _{CE} =5V, I _C =600mA | |
| Input Capacitance | C _{ies} | pF | — | 54000 | — | V _{CE} =10V, V _{GE} =0V, f=1MHz | |
| Switching Times | Rise Time | t _r | — | 0.2 | 0.5 | V _{CC} =600V, I _C =600A R _G =2.2Ω ^{*4} V _{GE} =±15V Inductive Load | |
| | Turn-On Time | t _{on} | — | 0.35 | 0.8 | | |
| | Fall Time | t _f | — | 0.15 | 0.35 | | |
| | Turn-Off Time | t _{off} | — | 0.75 | 1.2 | | |
| Peak Forward Voltage Drop | V _{FM} | V | — | 2.5 | 3.5 | I _F =600A, V _{GE} =0V | |
| Reverse Recovery Time | t _{rr} | μs | — | — | 0.4 | I _F =600A, V _{GE} =-10V, di/dt=600A/μs | |
| Thermal Impedance | IGBT | R _{th(j-c)} | °C/W | — | — | 0.033 | Junction to case |
| | FWD | R _{th(j-c)} | | | | | |

Notes; *4 : R_G value is the test condition's value for decision of the switching times, not recommended value, please determine the suitable R_G value after the measurement of switching waveforms (overshoot voltage, etc.) with appliance mounted.

Remark; For actual application, please confirm this spec. sheet is the newest revision.





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